

March 2013

FDPF085N10A

N-Channel PowerTrench $^{\mbox{\scriptsize R}}$ MOSFET 100 V, 40 A, 8.5 m Ω

Features

- $R_{DS(on)} = 6.5 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{V, } I_D = 40 \text{A}$
- · Fast Switching Speed
- Low Gate Charge, Q_G = 31 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

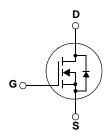
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Consumer Appliances
- LED TV
- Synchronous Rectification for ATX / Sever / Telecom PSU
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FDPF085N10A	Unit	
V _{DSS}	Drain to Source Voltage				V	
V _{GSS}	Gate to Source Voltage			±20	V	
	Drain Current	-Continuous (T _C = 25°C)		40	^	
I _D Drain Current		-Continuous (T _C = 100°C)		28	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	160	Α	
E _{AS}	Single Pulsed Avalanche E	nergy	(Note 2)	269	mJ	
dv/dt	Peak Diode Recovery dv/d	lt .	(Note 3)	6.0	V/ns	
D	Device Dissipation	$(T_C = 25^{\circ}C)$		33.3	W	
P_{D}	Power Dissipation	- Derate above 25°C		0.22	W/ºC	
T _J , T _{STG}	Operating and Storage Ter	mperature Range		-55 to +175	οС	
Γ _L	Maximum Lead Temperatu	- · · · · · · · · · · · · · · · · · · ·		300	°C	

Thermal Characteristics

Symbol	Parameter FDPF085N10A			
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max. 4.5			
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. 62.5		°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDPF085N10A	FDPF085N10A	TO-220F	=	=	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C	-	0.07	-	V/°C
1	Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$	-	-	1	μА
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 80V, T_C = 150^{\circ}C$	-	-	500	μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA

On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 96A$	-	6.5	8.5	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 10V, I_{D} = 96A$	-	76	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz		2025	2695	pF
C _{oss}	Output Capacitance			468	620	pF
C _{rss}	Reverse Transfer Capacitance			20	-	pF
C _{oss} (er)	Engry Related Output Capacitance	$V_{DS} = 50V$, $V_{GS} = 0V$		752	-	pF
Q _{g(tot)}	Total Gate Charge at 10V		-	31	40	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10V, V _{DS} = 50V	-	9.7	-	nC
Q _{gs2}	Gate Charge Threshoid to Plateau	I _D = 96A	-	5.0	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note	4) -	7.5	-	nC
ESR	Equivalent Series Resistance (G-S)	f = 1MHz	-	0.97	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time			-	18	46	ns
t _r	Turn-On Rise Time	$V_{DD} = 50V, I_{D} = 96A$		-	22	54	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V$, $R_{GEN} = 4.7\Omega$	-	-	29	68	ns
t _f	Turn-Off Fall Time	((Note 4)	-	8	26	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Diode Forward Current			-	40	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	160	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _{SD} = 96A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 50V, V_{GS} = 0V, I_{SD} = 96A$	-	59	-	ns
Q_{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	80	-	nC

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 3 mH, I $_{AS}$ = 13.4 A, R $_{G}$ = 25 $\!\Omega$, Starting T $_{J}$ = 25 $\!^{\circ}C$
- 3. I $_{SD} \leq$ 40 A, di/dt \leq 200A/ μ s, V $_{DD} \leq$ BV $_{DSS}$, Starting T $_{J}$ = 25°C
- 4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

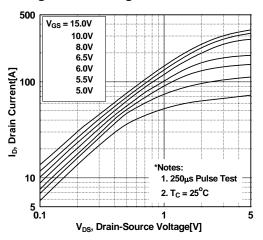


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

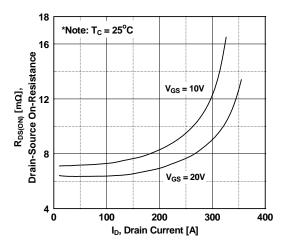


Figure 5. Capacitance Characteristics

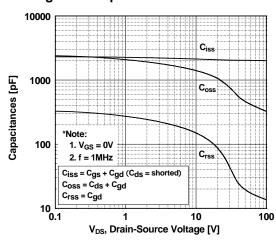


Figure 2. Transfer Characteristics

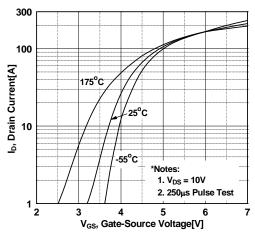


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

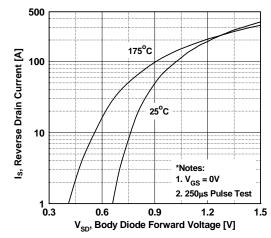
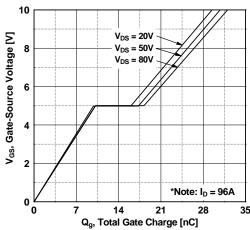


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

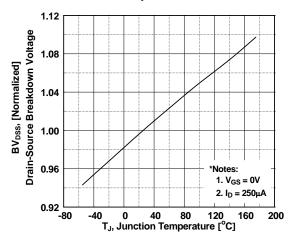


Figure 9. Maximum Safe Operating Area

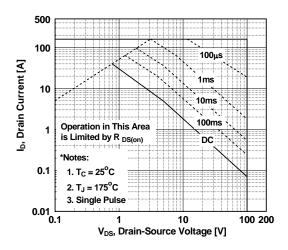


Figure 11. Eoss vs. Drain to Source Voltage

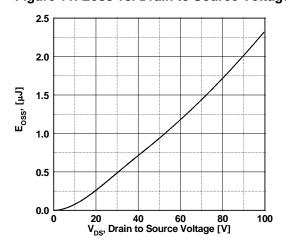


Figure 8. On-Resistance Variation vs. Temperature

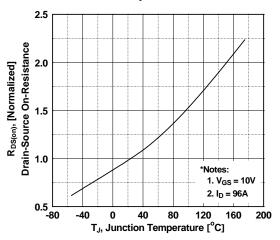


Figure 10. Maximum Drain Current vs. Case Temperature

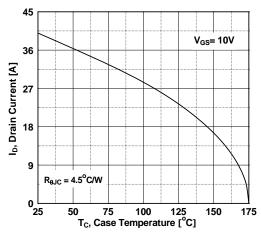
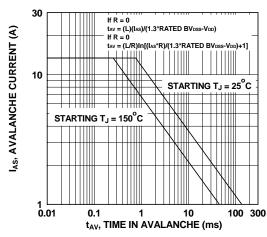
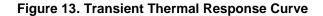
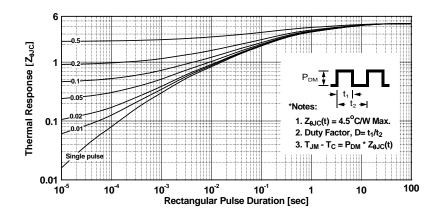


Figure 12. Unclamped Inductive Switching Capability

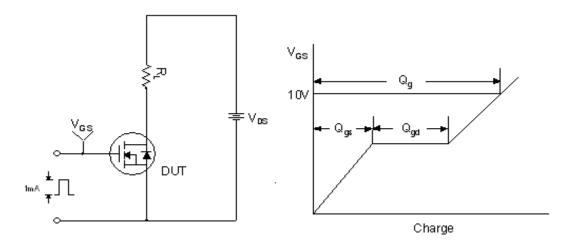


Typical Performance Characteristics (Continued)

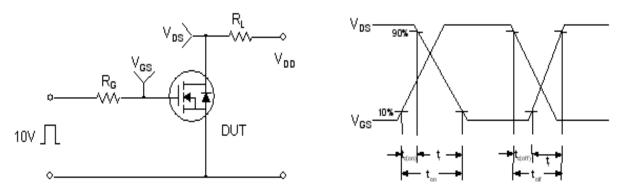




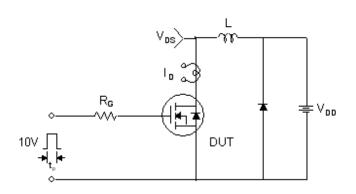
Gate Charge Test Circuit & Waveform

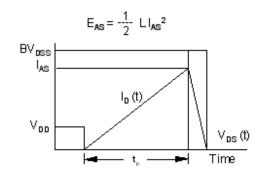


Resistive Switching Test Circuit & Waveforms

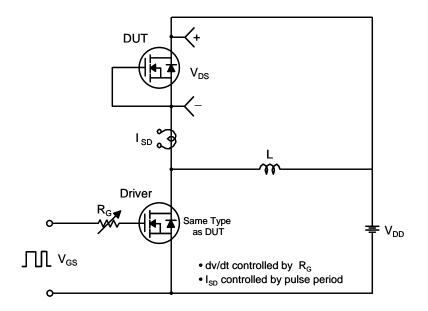


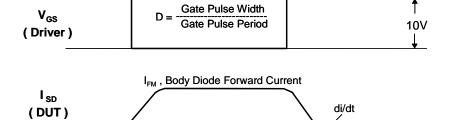
Unclamped Inductive Switching Test Circuit & Waveforms





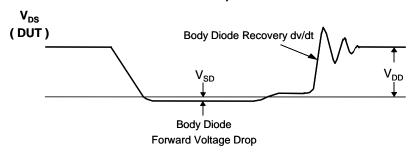
Peak Diode Recovery dv/dt Test Circuit & Waveforms





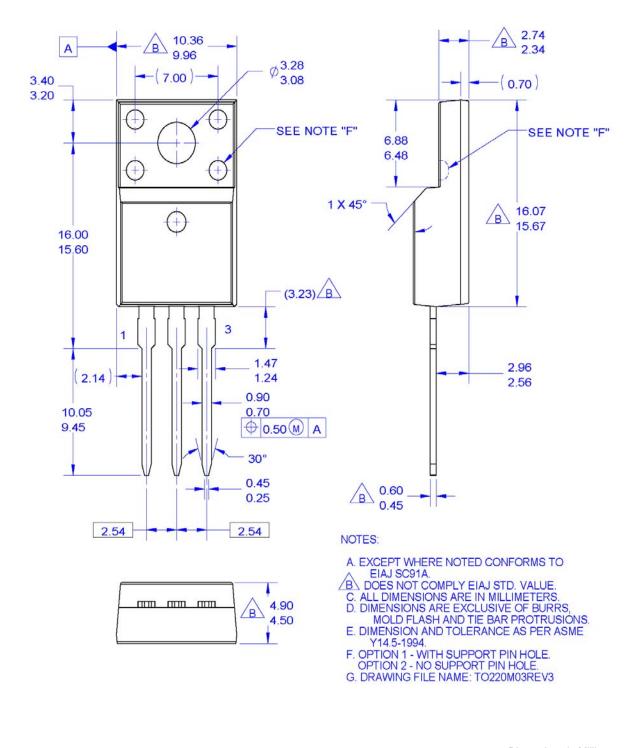
Body Diode Reverse Current

 \mathbf{I}_{RM}



Mechanical Dimensions

TO-220M03







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